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N-Channel PowerTrench[®] MOSFET 30 V, 7.5 m Ω

Features

- Max $r_{DS(on)}$ = 7.5 m Ω at V_{GS} = 10 V, I_D = 13 A
- Max $r_{DS(on)}$ = 13 m Ω at V_{GS} = 4.5 V, I_D = 10 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery.
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

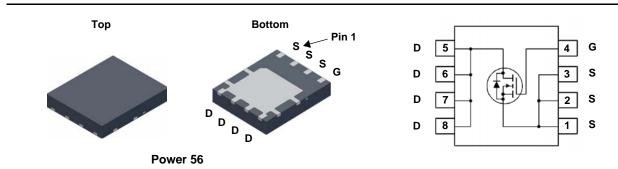


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{DSt}	Drain to Source Transient Voltage (tTransient	< 100 ns)		33	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		28		
	-Continuous (Silicon limited)	T _C = 25 °C		47	•	
D	-Continuous	T _A = 25 °C	(Note 1a)	14	Α	
	-Pulsed			50		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	21	mJ	
	Power Dissipation	T _C = 25 °C		27		
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	4	4.6	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Not	te 1a)	50	C/W	

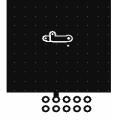
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7692	FDMS7692	Power 56	13 "	12 mm	3000 units

January 2015

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	nch	Pow

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	30			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		13		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
GSS	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.2	2.0	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
0	•	V _{GS} = 10 V, I _D = 13 A		6.5	7.5	
DS(on)	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		9.5	13	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		9.0	11	
9fs	Forward Transconductance	V _{DS} = 5 V, I _D = 13 A		68		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V 45.V.V. 0.V.		1015	1350	pF
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		325	435	pF
C _{rss}	Reverse Transfer Capacitance			45	65	pF
R _g	Gate Resistance			1.0	2.0	Ω
Switchin	g Characteristics					
d(on)	Turn-On Delay Time			8	16	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 13 A,		2.7	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		17	31	ns
<u>u(0.1)</u> f	Fall Time			2.3	10	ns
Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		15	22	nC
	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$		7	10	nC
0		I _D = 13 A		3.4		nC
Qg	Gate to Source Charge	В				nC
Q _g Q _{gs}	Gate to Source Charge Gate to Drain "Miller" Charge			1.9		
Q _g Q _{gs} Q _{gd}	5			1.9		
Q _g Q _{gs} Q _{gd} Drain-So	Gate to Drain "Miller" Charge	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A}$ (Note 2)		1.9 0.75	1.1	V
ସୁ ପୁ _{gs} ପୁ _{gd}	Gate to Drain "Miller" Charge				1.1 1.2	- V
ລ _g ລ _{gs} ລ _{gd} Drain-So V _{SD}	Gate to Drain "Miller" Charge ource Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A} \qquad (\text{Note 2})$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 13 \text{ A} \qquad (\text{Note 2})$		0.75		- V ns
ລ _g ລ _{gs} ລ _{gd} Drain-So √ _{SD}	Gate to Drain "Miller" Charge ource Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time Reverse Recovery Charge	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A}$ (Note 2)		0.75 0.84	1.2	
ລ _{ິງ} ລ _{ິງs} ລ _{ິງd} Drain-So	Gate to Drain "Miller" Charge ource Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.1 \text{ A} \qquad (\text{Note 2})$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 13 \text{ A} \qquad (\text{Note 2})$		0.75 0.84 21	1.2 34	ns



1 in² pad of 2 oz copper.

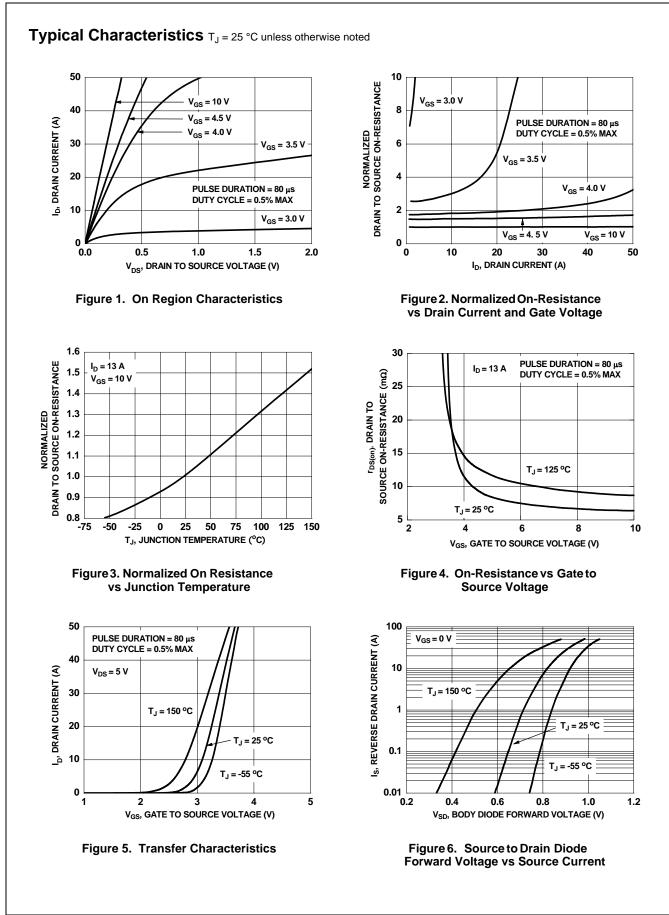
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



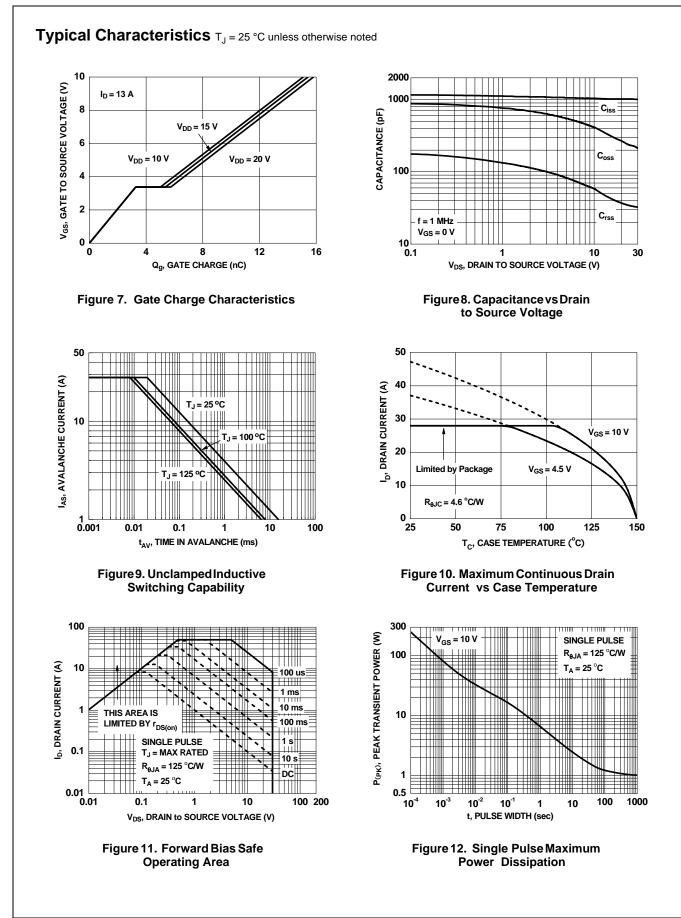
•**1**

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. Starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 12 A, V_{DD} = 27 V, V_{GS} = 10 V.

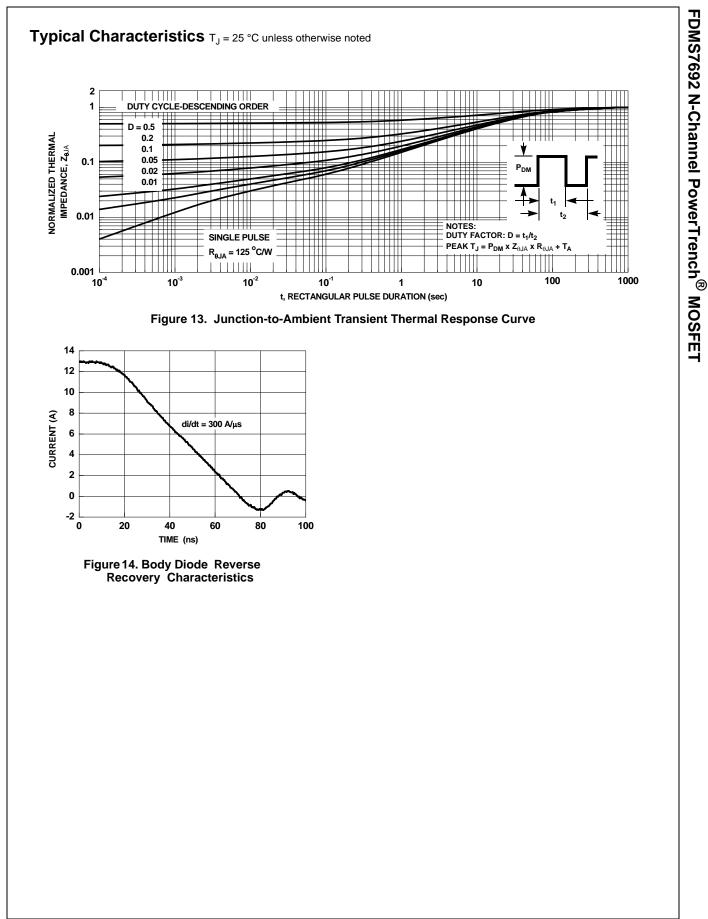
FDMS7692 N-Channel PowerTrench[®] MOSFET

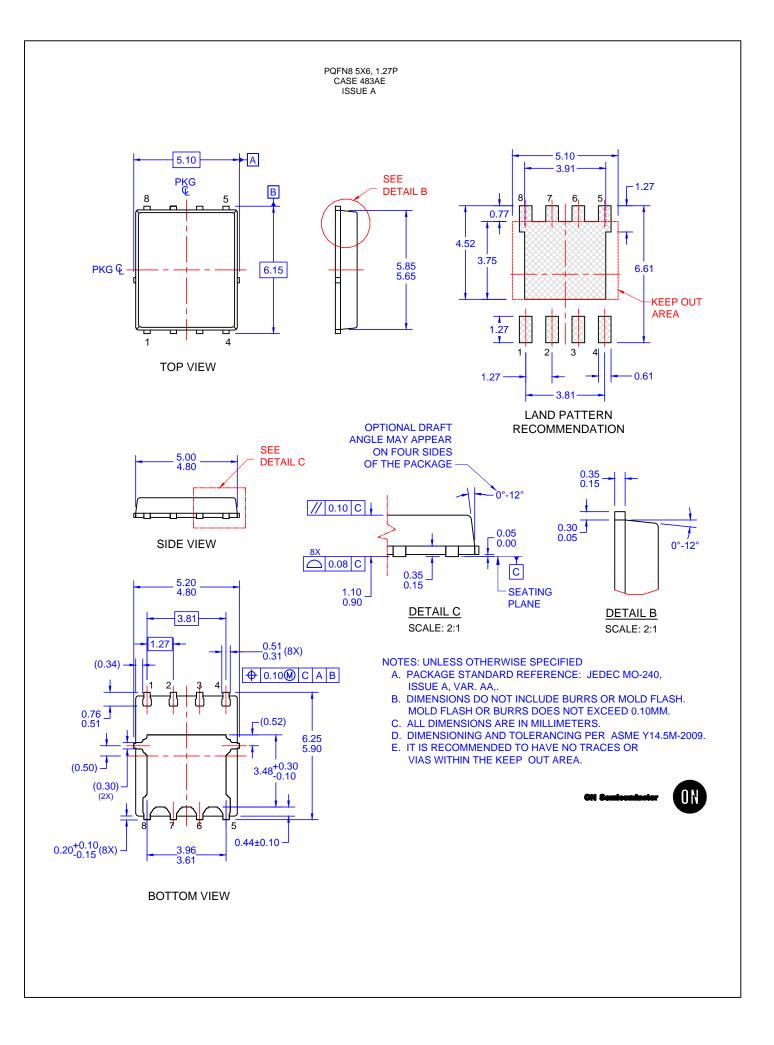






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